

**Features**

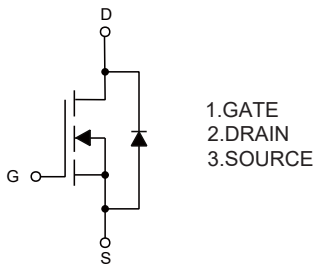
- High Current Rating
- Lower  $R_{DS(ON)}$
- Lower Capacitance
- Lower Total Gate Charge
- Tighter  $V_{SD}$  Specifications
- Avalanche Energy Specified
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

**Maximum Ratings**

- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 100°C/W Junction to Ambient

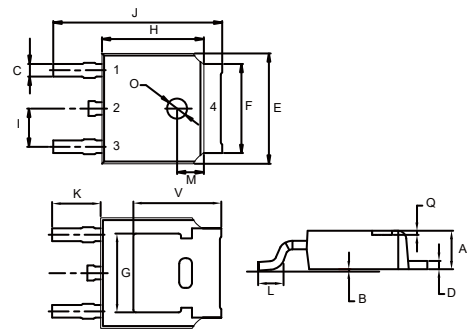
Parameter	Symbol	Rating	Unit
Drain -Source Voltage	$V_{DS}$	600	V
Gate -Source Voltage	$V_{GS}$	±30	V
Drain Current-Continuous	$I_D$	4.5	A
Power Dissipation@ $T_C=25^\circ\text{C}$ (Note 2)	$P_D$	1.25	W
Maximum Power Dissipation@ $T_C=25^\circ\text{C}$ (Note 3)			
Single Pulsed Avalanche Energy(Note 1)	$E_{AS}$	210	mJ

**Internal Structure**



**N-CHANNEL  
MOSFET**

**DPAK**



DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	0.087	0.094	2.20	2.40	
B	0.000	0.005	0.00	0.13	
C	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
E	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		TYP.
H	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.114		2.90		TYP.
L	0.055	0.067	1.40	1.70	
M	0.063		1.60		TYP.
O	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.35		TYP.

**ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)**

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	600			V
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	V
Gate-Body Leakage Current <sup>(Note4)</sup>	$I_{GSS}$	$V_{GS} = \pm 30V, V_{DS} = 0V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 600V, V_{GS} = 0V$			1	$\mu A$
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=2.25A$			2.5	$\Omega$
Drain- Source Diode Forward Voltage <sup>(Note4)</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = 4.5A$			1.4	V
Forward Transconductance <sup>(Note4)</sup>	$g_{fs}$	$V_{DS}=40V, I_D=2.25A$	2.9			S
<b>Dynamic Characteristics</b>						
Input Capacitance <sup>(Note4)</sup>	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1MHz$			670	pF
Output Capacitance <sup>(Note4)</sup>	$C_{oss}$				72	
Reverse Transfer Capacitance <sup>(Note4)</sup>	$C_{rss}$				8.5	
<b>Switching Characteristics</b>						
Turn-on Delay Time <sup>(Note4)</sup>	$t_{d(on)}$	$V_{DD}=300V, R_G=25\Omega, I_D=4.5A$			30	ns
Turn-on Rise Time <sup>(Note4)</sup>	$t_r$				90	
Turn-off Delay Time <sup>(Note4)</sup>	$t_{d(off)}$				85	
Turn-off Fall Time <sup>(Note4)</sup>	$t_f$				100	

Note: 1. EAS Condition:  $L=20mH, I_{AS}=4.5A, V_{DD}=50V, R_G=25\Omega, T_J=25^\circ C$

2. This Test is Performed With No Heat Sink at  $T_A=25^\circ C$

3. This Test is Performed With Infinite Heat Sink at  $T_C=25^\circ C$

4. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .

Curve Characteristics

Fig. 1 - Output Characteristics

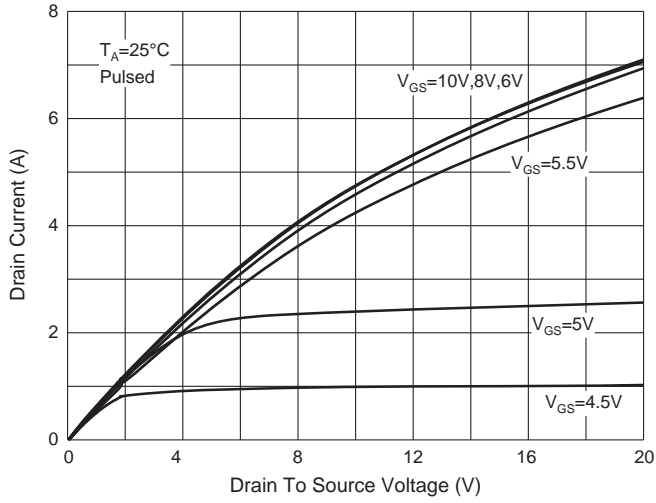


Fig. 2 - Transfer Characteristics

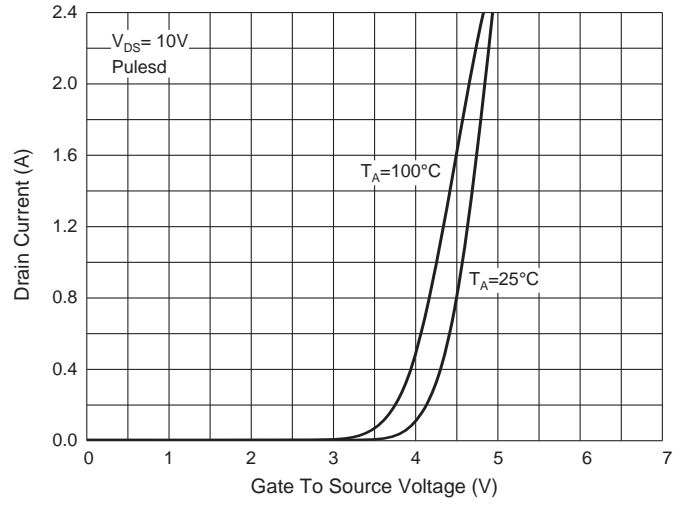


Fig. 3 -  $R_{DS(ON)} - I_D$

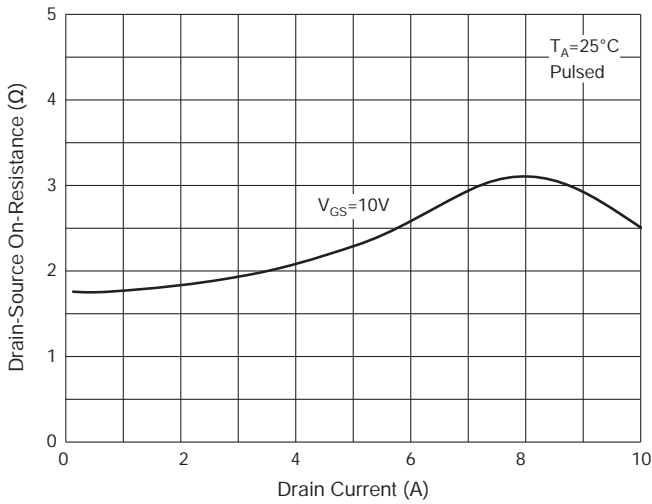


Fig. 4 -  $R_{DS(ON)} - V_{GS}$

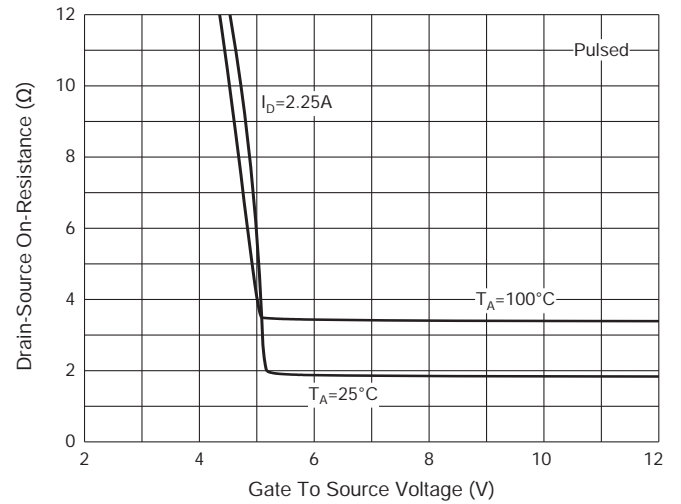


Fig. 5 -  $I_S - V_{SD}$

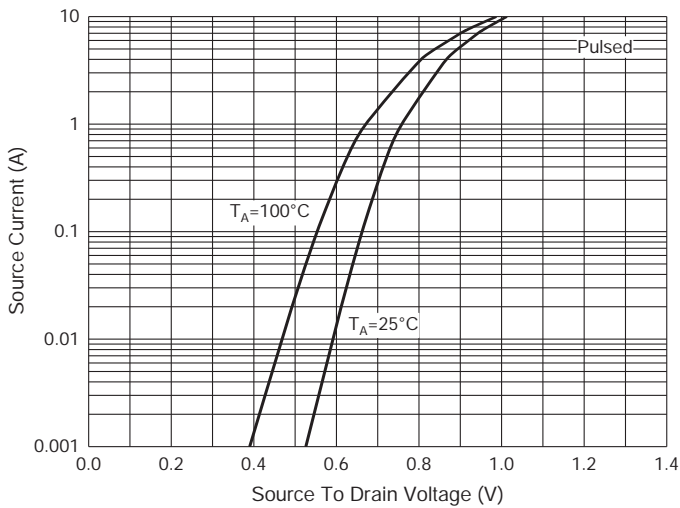
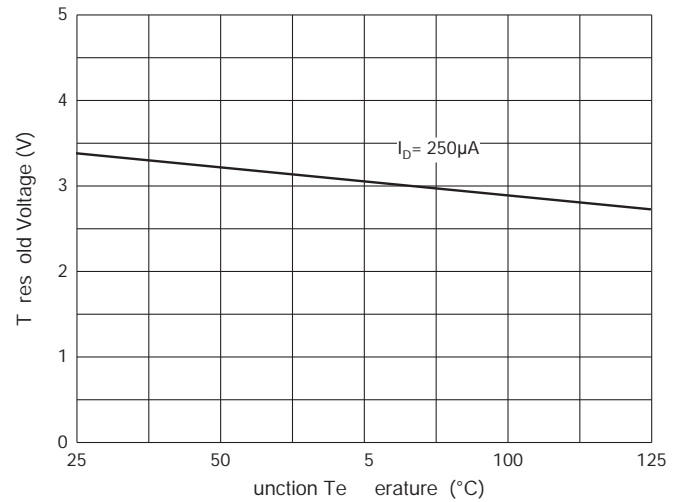


Fig. 6 - Thermal Resistance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:2.5Kpcs/Reel

Note : Adding "-HF" Suffix For Halogen Free, eg. Part Number-TP-HF

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